

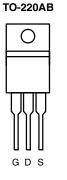
Vishay Siliconix

N-Channel 250-V (D-S) 175 °C MOSFET

PRODUCT SUMMARY			
V _{DS} (V)	r _{DS(on)} (Ω)	I _D (A)	
250	0.165 at V _{GS} = 10 V	17	

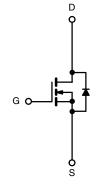
FEATURES

- TrenchFET[®] Power MOSFET
- 175 °C Junction Temperature



Top View

Ordering Information: SUP17N25-165-E3



N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS	T _A = 25 °C, unless oth	nerwise noted			
Parameter		Symbol	Limit	Unit	
Drain-Source Voltage		V _{DS}	250	v	
Gate-Source Voltage		V _{GS} ± 20		V	
	T _C = 25 °C	1-	17		
Continuous Drain Current $(T_J = 175 \ ^{\circ}C)^b$	T _C = 125 °C		9.8	A	
Pulsed Drain Current		I _{DM}	20		
Single Pulse Avalanche Current		I _{AS}	5		
Single Pulse Avalanche Energy L = 0.1 mH		E _{AS}	1.25	mJ	
Manimum Davier Disaination	T _C = 25 °C	Р	136 ^b	w	
Maximum Power Dissipation	T _A = 25 °C	– P _D –	3.75 ^a		
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 175	°C	

THERMAL RESISTANCE RATINGS				
Parameter	Symbol	Limit	Unit	
Junction-to-Ambient ^a	R _{thJA}	40	°C/W	
Junction-to-Case (Drain)	R _{thJC}	1.1		

Notes:

a. Surface Mounted on 1" x 1" FR4 Board.b. See SOA curve for voltage derating.

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Parameter	Symbol	Test Conditions	Min	Тур ^а	Max	Unit	
Static		·					
Drain-Source Breakdown Voltage	V _{(BR)DSS}	$V_{GS} = 0 \text{ V}, \text{ I}_{D} = 250 \mu\text{A}$	250			v	
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$	2.5		4.0	V	
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 100	nA	
Zero Gate Voltage Drain Current		$V_{DS} = 250 \text{ V}, V_{GS} = 0 \text{ V}$			1	μΑ	
	I _{DSS}	$V_{DS} = 250 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 125 \text{ °C}$			50		
		V_{DS} = 250 V, V_{GS} = 0 V, T_{J} = 175 °C			250		
On-State Drain Current ^b	I _{D(on)}	$V_{DS} = 15 \text{ V}, V_{GS} = 10 \text{ V}$	17			А	
Drain-Source On-State Resistance ^b		V _{GS} = 10 V, I _D = 14 A		0.130	0.165	Ω	
	r _{DS(on)}	V_{GS} = 10 V, I _D = 14 A, T _J = 125 °C			0.347		
		V_{GS} = 10 V, I _D = 14 A, T _J = 175 °C			0.462		
Forward Transconductance ^b	9 _{fs}	V _{DS} = 15 V, I _D = 17 A		36		S	
Dynamic ^a		· · · · · ·					
Input Capacitance	C _{iss}	V _{GS} = 0 V, V _{DS} = 25 V, f = 1 MHz		1950		pF	
Output Capacitance	C _{oss}			160			
Reverse Transfer Capacitance	C _{rss}			70			
Total Gate Charge ^c	Qg			30	45	nC	
Gate-Source Charge ^c	Q _{gs}	V_{DS} = 125 V, V_{GS} = 10 V, I_{D} = 17 A		10			
Gate-Drain Charge ^c	Q _{gd}			10			
Gate Resistance	Rg	f = 1 MHz		1.6		Ω	
Turn-On Delay Time ^c	t _{d(on)}			15	25		
Rise Time ^c	t _r	$V_{\text{DD}} = 125 \text{ V}, \text{ R}_{\text{L}} = 7.35 \Omega$ $\text{I}_{\text{D}} \cong 17 \text{ A}, \text{ V}_{\text{GEN}} = 10 \text{ V}, \text{ R}_{\text{g}} = 2.5 \Omega$		130	195	ns	
Turn-Off Delay Time ^c	t _{d(off)}			30	45		
Fall Time ^c	t _f			100	150		
Source-Drain Diode Ratings and Cha	aracteristics	(T _C = 25 °C)					
Continuous Current	ا _S				17	۸	
Pulsed Current	I _{SM}				20	A	
Forward Voltage ^a	V _{SD}	I _F = 17 A, V _{GS} = 0 V		0.9	1.5	V	
Reverse Recovery Time	t _{rr}			115	175	ns	
Peak Reverse Recovery Current	I _{RM(REC)}	I _F = 17 A, di/dt = 100 A/μs		10	15	А	
Reverse Recovery Charge	Q _{rr}			0.58	1.3	μC	

Notes:

a. Guaranteed by design, not subject to production testing.

b. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %.

c. Independent of operating temperature.

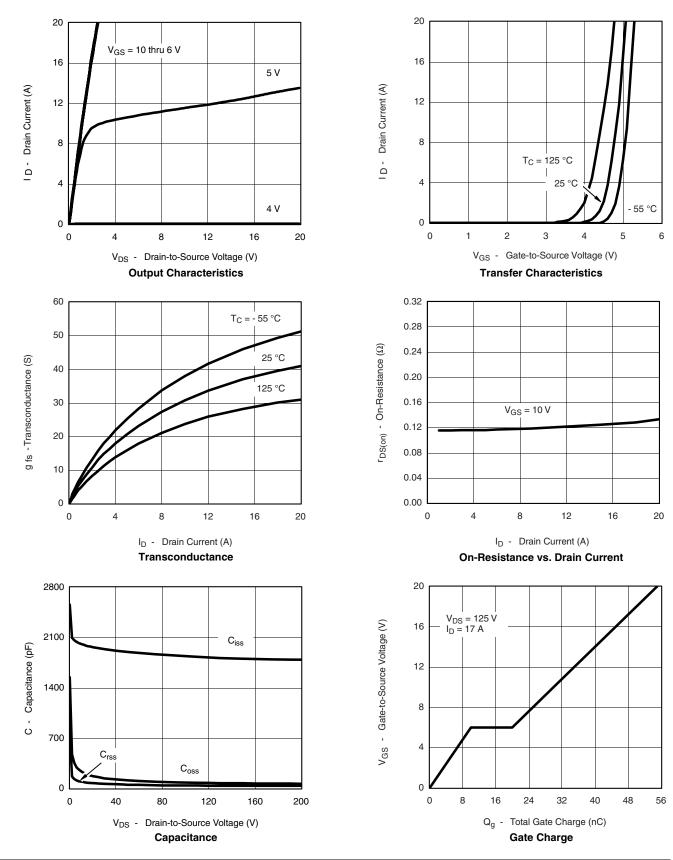
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



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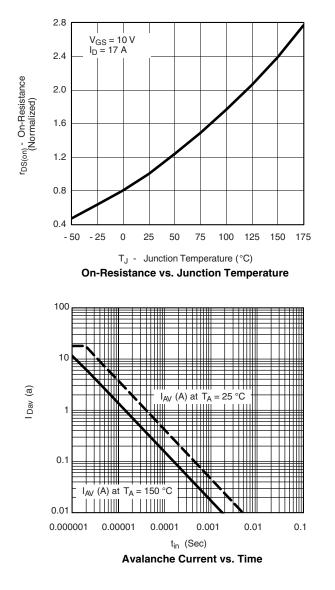
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

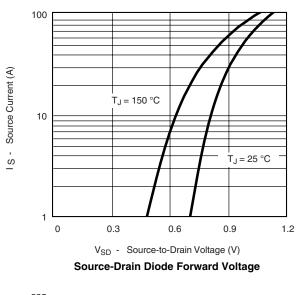


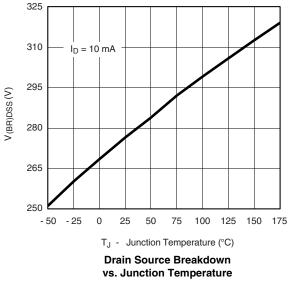
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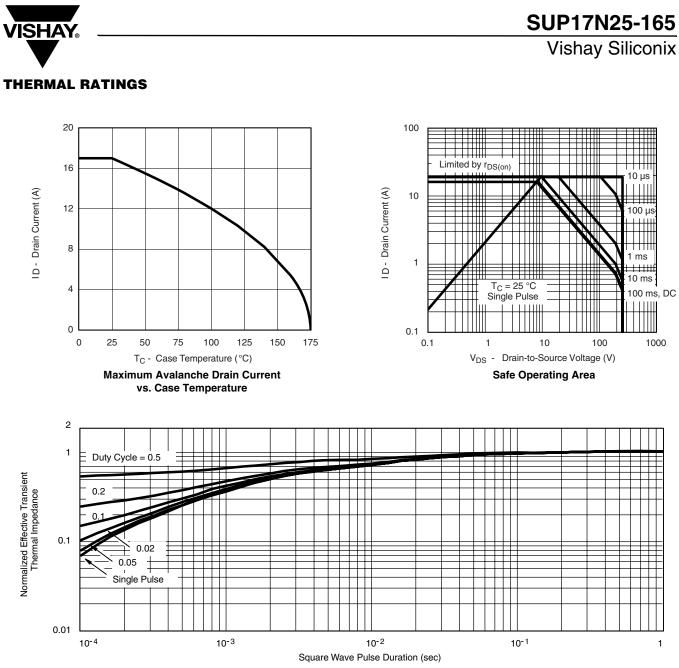
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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted









Normalized Thermal Transient Impedance, Junction-to-Case

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see http://www.vishay.com/ppg?72850.



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